



### MMBD4448H SURFACE MOUNT SWITCHING DIODE

#### **Features**

- Fast Switching Speed
- Surface Mount Package Ideally Suited for Automated Insertion
- For General Purpose Switching Applications
- High Conductance
- Lead Free/RoHS Compliant (Note 1)

#### **Mechanical Data**

- Case: SOT23
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Polarity: See Diagram
- Weight: 0.008 grams (approximate)



Top View

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Top View Internal Schematic

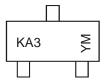
### Ordering Information (Note 2)

Part Number	Case	Packaging
MMBD4448H-7-F	SOT23	3000/Tape & Reel

Notes: 1. No purposefully added lead.

2. For packaging details, go to our website at http://www.diodes.com.

# **Marking Information**



 $\begin{array}{l} \mathsf{KA3} = \mathsf{Product} \ \mathsf{Type} \ \mathsf{Marking} \ \mathsf{Code} \\ \mathsf{YM} = \mathsf{Date} \ \mathsf{Code} \ \mathsf{Marking} \\ \mathsf{Y} = \mathsf{Year} \ (\mathsf{ex:} \ \mathsf{N} = 2002) \\ \mathsf{M} = \mathsf{Month} \ (\mathsf{ex:} \ 9 = \mathsf{September}) \end{array}$ 

Date Code Key

Year	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012	2013	2014	2015
Code	М	Ν	Р	R	S	Т	U	V	W	Х	Y	Z	А	В	С
Month	Jan	Fe	b	Mar	Apr	May	Ju	n	Jul	Aug	Sep	Oc	t I	lov	Dec
Code	1	2		3	4	5	6		7	8	9	0		Ν	D



# **Maximum Ratings** $@T_A = 25^{\circ}C$ unless otherwise specified

Characteristic		Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage		V <sub>RM</sub>	100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	80	V
RMS Reverse Voltage		V <sub>R(RMS)</sub>	57	V
Forward Continuous Current (Note 3)		I <sub>FM</sub>	500	mA
Average Rectified Output Current (Note 3)		lo	250	mA
Non-Repetitive Peak Forward Surge Current	@ t = 1.0μs @ t = 1.0s	I <sub>FSM</sub>	4.0 1.0	А

#### **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 3)	PD	350	mW
Thermal Resistance Junction to Ambient Air (Note 3)	R <sub>0JA</sub>	357	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

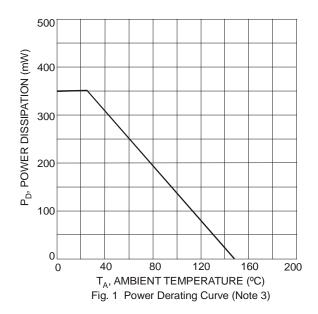
## Electrical Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

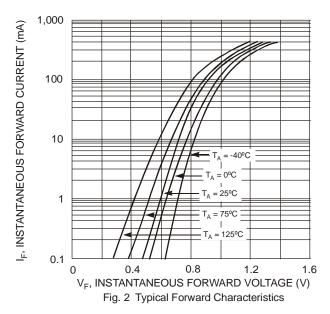
Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 4)	V <sub>(BR)R</sub>	80		V	$I_R = 2.5 \mu A$
		0.62	0.72		I <sub>F</sub> = 5.0mA
Forward Voltage	VF		0.855	V	$I_F = 10 \text{mA}$
rorward voltage	٧F	—	1.0	v	I <sub>F</sub> = 100mA
		_	1.25		I <sub>F</sub> = 150mA
			100	nA	V <sub>R</sub> = 70V
Reverse Current (Note 4)			50	μΑ	V <sub>R</sub> = 75V, T <sub>J</sub> = 150°C
Reverse Current (Note 4)	I <sub>R</sub>	_	30	μA	V <sub>R</sub> = 25V, T <sub>J</sub> = 150°C
			25	nA	$V_R = 20V$
Total Capacitance	CT		3.5	pF	$V_{R} = 6V, f = 1.0MHz$
Reverse Recovery Time	t <sub>rr</sub>	_	4.0	ns	$V_{R} = 6V, I_{F} = 5mA$

Notes:

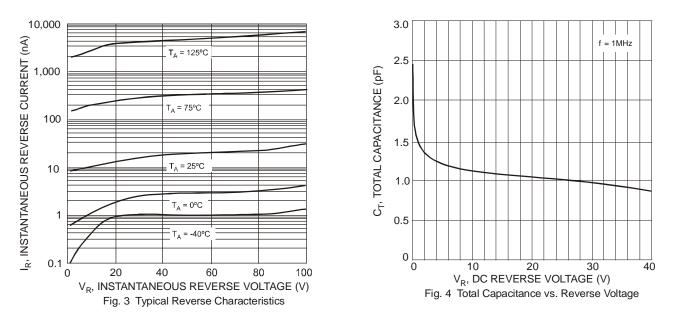
3. Part mounted on FR-4 board with recommended pad layout, which can be found on our website at http://www.diodes.com.

4. Short duration pulse test used to minimize self-heating effect.

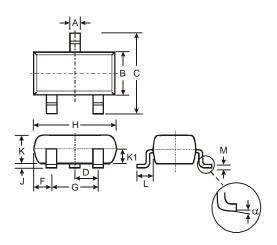






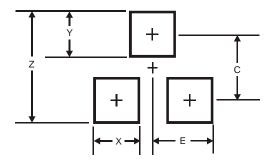


# **Package Outline Dimensions**



	SOT23							
Dim	Min	Max	Тур					
Α	0.37	0.51	0.40					
В	1.20	1.40	1.30					
С	2.30	2.50	2.40					
D	0.89	1.03	0.915					
F	0.45	0.60	0.535					
G	1.78	2.05	1.83					
Н	2.80	3.00	2.90					
J	0.013	0.10	0.05					
κ	0.903	1.10	1.00					
K1	-	-	0.400					
L	0.45	0.61	0.55					
М	0.085	0.18	0.11					
α	0°	8°	-					
All	All Dimensions in mm							

# **Suggested Pad Layout**



Dimensions	Value (in mm)
Z	2.9
Х	0.8
Y	0.9
С	2.0
E	1.35



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